

HDSC Series

Features

- Two parallel resistance elements in a single chip
- Excellent pulse withstand performance
- Enhanced working voltage
- Enhanced power rating
- Anti-sulphur



All Pb-free parts comply with EU Directive 2011/65/EU amended by (EU) 2015/863 (RoHS3)

Electrical Data

		0805	1206	2010	2512
Power @70°C	W	0.25	0.33	0.75	1.5
2 second overload power@25°C	W	1.6	2.1	4.7	9.4
Short pulse performance		See graphs			
Resistance range	ohms	0R5 to 1M0			
Tolerance	%	5, 10, 20			
LEV	V	150	200	400	500
TCR	ppm/°C	<10R:300 ≥10R:100			
Operating temperature	°C	-55 to +155			
Dielectric withstand voltage	V	300	500		
Thermal Impedance	°C/W	210	160	80	50
Pad & trace area for rated power*	mm ²	40	50	60	100
Values		E24 preferred- other values to special order			

*Recommended minimum pad & adjacent trace area for each termination for rated power dissipation on FR4 PCB

Physical Data

Dimensions (mm) & Weight (mg)							
	L	W	T max	A	B min	C	Wt.
0805	2.0±0.15	1.25±0.15	0.7	0.3±0.15	0.9	0.3±0.1	5.0
1206	3.2±0.2	1.6±0.2	0.7	0.4±0.2	1.7	0.4±0.15	10
2010	5.1±0.3	2.5±0.2	0.8	0.6±0.3	3.0	0.6±0.25	42
2512	6.5±0.3	3.2±0.2	0.8	0.6±0.3	4.4	0.6±0.25	65

Wrap-around terminations (3 faces)

Construction

Thick film resistor material, overglaze and organic protection are screen printed on a 96% alumina substrate. Wrap-around terminations have an electroplated nickel barrier and solderable coating; this ensures excellent 'leach' resistance properties and solderability.

Marking

Components are not marked. Reels are marked with type, value, tolerance, date code and quantity.

Solvent Resistance

The body protection is resistant to all normal industrial cleaning solvents suitable for printed circuits.

General Note

TT Electronics reserves the right to make changes in product specification without notice or liability. All information is subject to TT Electronics' own data and is considered accurate at time of going to print.

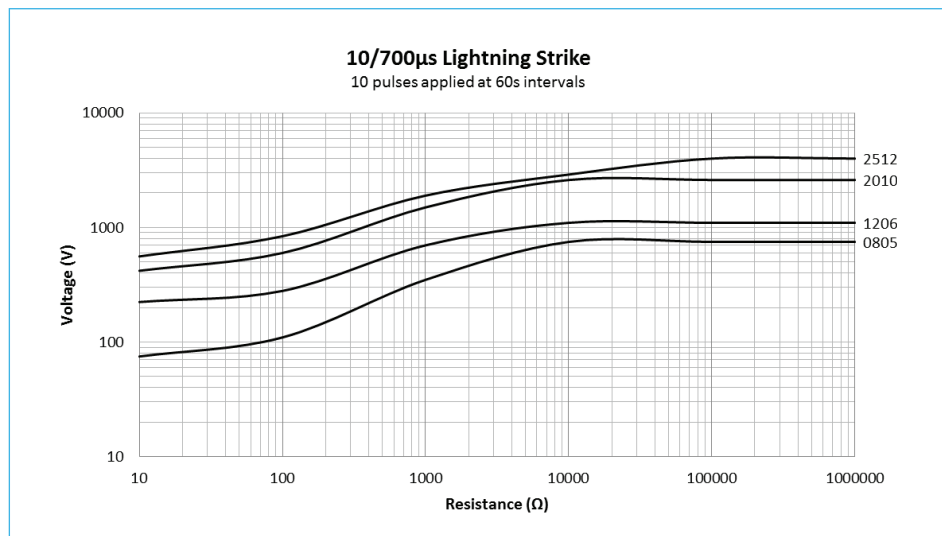
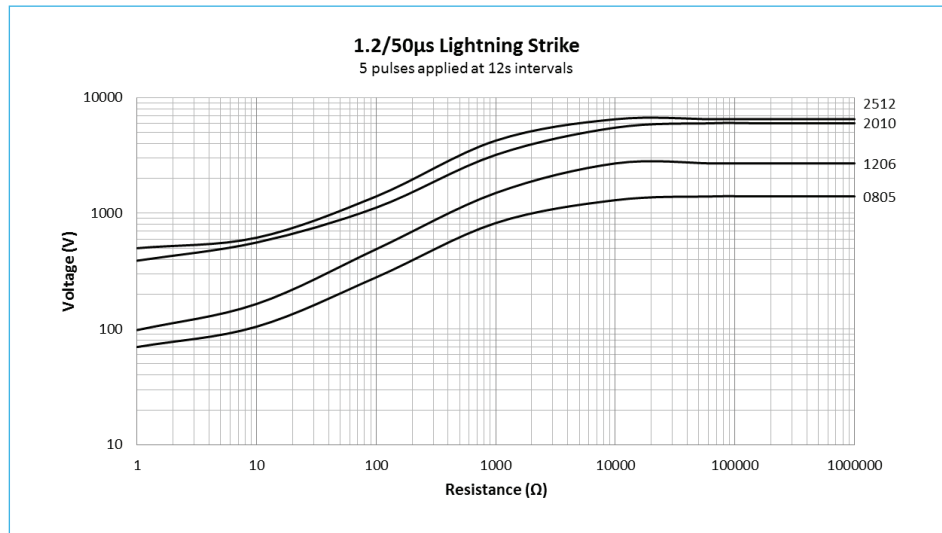
Performance Data

		Maximum	Typical
Load at rated power: 1000 hours at 70°C	ΔR%	1	0.25
Derating from rated power at 70°C		Zero at 155°C	
Overload: 6.25 x rated power for 2 seconds	ΔR%	1	0.1
Shelf life test: 12 months at room temperature	ΔR%	0.1	0.02
Dry heat: 1000 hours at 155°C	ΔR%	1	0.2
Long term damp heat	ΔR%	1	0.25
Temperature rapid change	ΔR%	0.25	0.05
Resistance to sulphur-bearing gas EIA-977 & ASTM-B-809	ΔR%	0.25	0.05
Resistance to solder heat	ΔR%	0.25	0.05

Pulse Performance Data

Lightning Surge

Resistors are tested in accordance with IEC 60 115-1 using both 1.2/50μs and 10/700μs pulse shapes. 10 pulses are applied. The limit of acceptance is a shift in resistance of less than 1% from the initial value

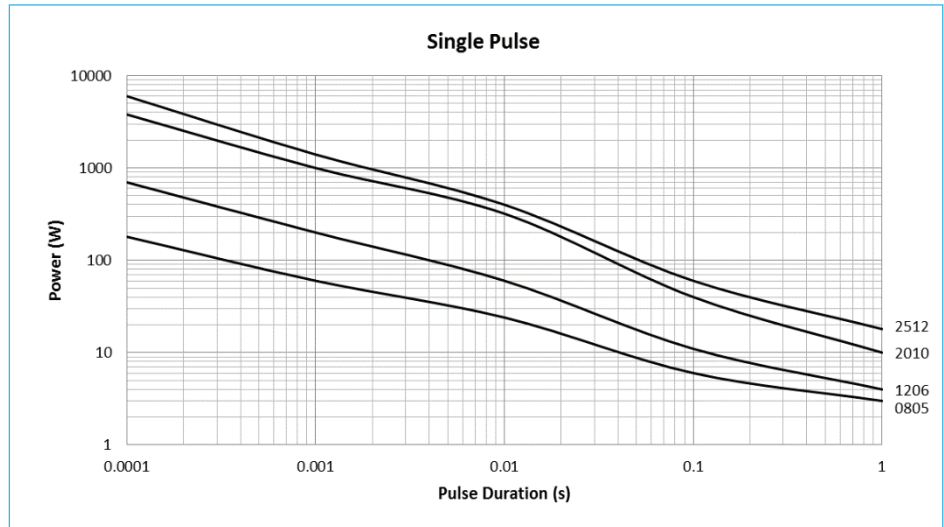


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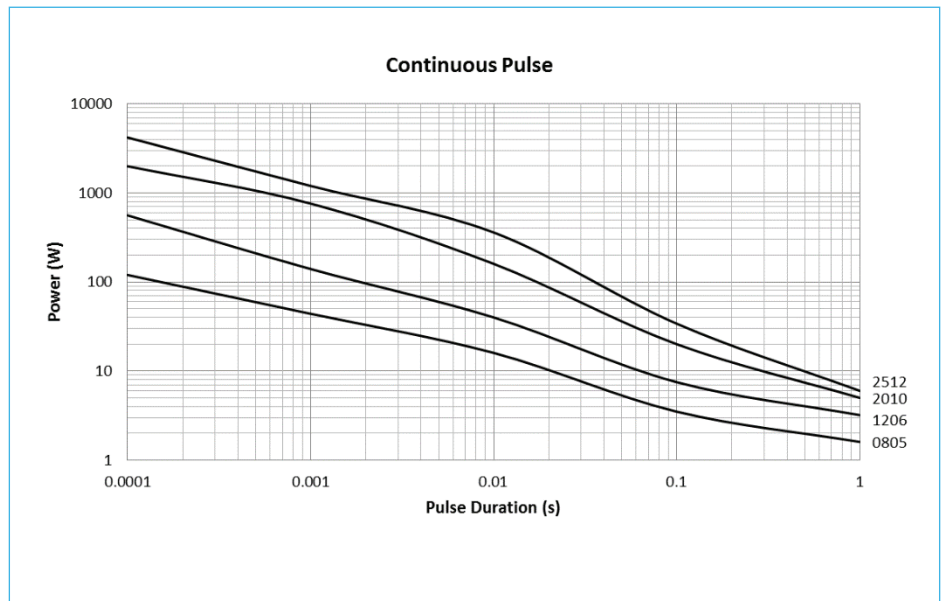
Single Pulse

The single impulse graph is the result of 50 impulses of rectangular shape applied at one-minute intervals. The limit of acceptance was a shift in resistance of less than 1% from the initial value.



Continuous Load Due to Repetitive Pulses

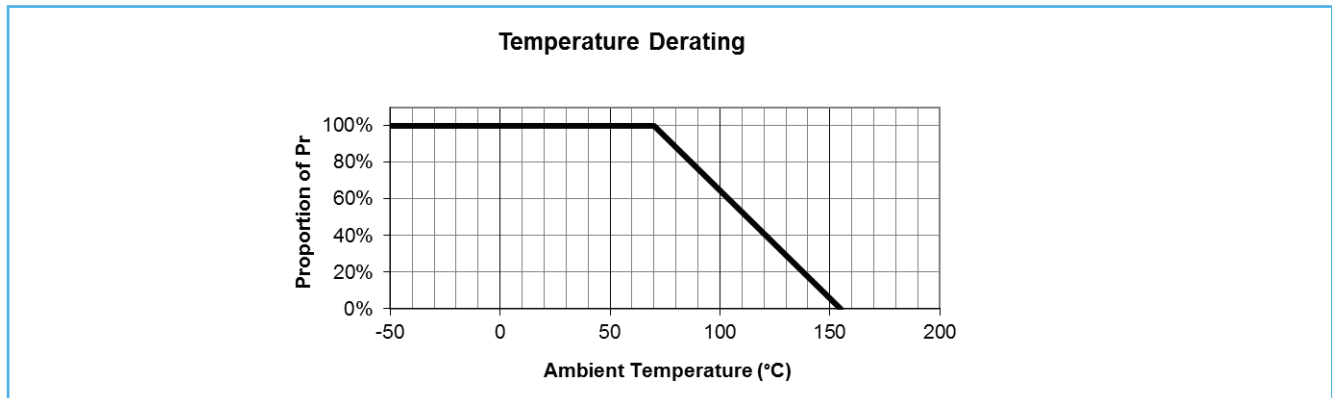
The continuous load graph was obtained by applying repetitive rectangular pulses where the pulse period was adjusted so that the average power dissipated in the resistor was equal to its rated power at 70°C. Again the limit of acceptance was a shift in resistance of less than 1% from the initial value..



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Thermal Performance Data



Packaging

0805 and 1206 resistors are supplied on 8mm carrier tape and 2010 and 2512 resistors are supplied on 12 mm carrier tape, all on 7 inch reels as per IEC 286-3.

Application Notes

HDSC resistors are ideally suited for handling by automatic methods due to their rectangular shape and the small dimensional tolerances. Electrical connection to a ceramic substrate or to a printed circuit board can be made by reflow or wave ... soldering of wrap-around terminations. For reflow processing of HDSC parts, a solder paste thickness of not less than 100µm is recommended.

Wrap-around terminations provide good leach properties and ensure reliable contact. Due to the robust construction, the HDSC can be immersed in the solder bath for 30 seconds at 260°C. This enables the resistor to be mounted on one side of a printed circuit board and wire-leaded components applied on the other side. HDSC is compatible with typical Pb-free soldering materials and temperature profiles.

HDSC resistors themselves can operate at a maximum temperature of 155°C. For soldered resistors, the joint temperature should not exceed 110°C. This condition is met when the stated power levels at 70°C and recommended pad and trace areas are used. Pad and trace area is defined as the total area of the solder pad plus all copper trace within two squares of the edge of the solder pad. Allowance should be made if smaller areas of copper are used.

Ordering Procedure

Example: HDSC2512-10KJT18 (HDSC2512, 10 kilohms ±5%, Pb-free)



1 Type	2 Size	3 Value	4 Tolerance	5 Termination & Packing		
HDSC	0805	E24 = 3/4 characters R = ohms K = kilohms M = megohms	J = ±5%	Standard Pb-free finish		
	1206		K = ±10%	T3	0805	
	2010		M = ±20%		1206	3000/reel standard
	2512			T18	2512	
				T1	All sizes	1000/reel available
SnPb finish						
				PB	All sizes	Standard quantities as for Pb-free

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